

SGH30N60RUFDTU alternative

IGBT Transistors Dis Short Circuit Rated IGBT



SGH30N60RUFDTU alternative Datasheet

600V Trench and Fieldstop IGBT

PRODUCT SUMMARY	
V _{CE} (V)	600
I _C (A)	40 (TC=25°C) 20 (TC=100°C)
V _{CE (sat)} (V)	1.8
I _{CM} (A)	60

FEATURES

- Very Low V_{CEsat}
- Low turn-off losses
- High speed switching
- Maximum junction temperature 175°C
- Ultra low gate charge (Q_g)
- Avalanche energy rated (UIS)



RoHS
COMPLIANT
HALOGEN
FREE

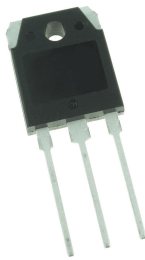
APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Consumer and computing
 - ATX power supplies
- Industrial
 - Welding
 - Battery chargers
- Renewable energy
 - Solar (PV inverters)
- Switch mode power supplies (SMPS)

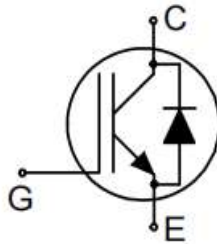
Package pin definition

- Pin1 G - Gate
- Pin2 C & backside - Collector
- Pin3 E - Emitter

TO-3P



Top View



ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)				
PARAMETER	SYMBOL	LIMIT	UNIT	
Collector-Emitter Voltage	V _{CE}	600	V	
Gate-Emitter Voltage	V _{GE}	±30		
Continuous Collector Current (T _J = 150 °C)	V _{GE} at 15 V	T _C = 25 °C	A	
		T _C = 100 °C		
Pulsed Collector Current ^a	I _{CM}	60		
Diode Forward Current ^b	I _F	20	A	
Maximum Power Dissipation		T _C = 25 °C	65	W
		T _C = 100 °C	15.0	W
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +175	°C	
Short Circuit Withstand Time ^{TC=150°C}	V _{GE} = 15V, V _{CE} ≤ 400V	3	μs	
Short Circuit Withstand Time ^{TC=100°C}	V _{GE} = 15V, V _{CE} ≤ 330V			
Soldering Recommendations (Peak Temperature) ^c	for 10 s	260	°C	

Notes

- Repetitive rating; pulse width limited by maximum junction temperature.
- Current limited by maximum junction temperature.
- 1.6 mm from case.

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R_{thJA}	-	78	°C/W
Maximum Junction-to-Case	R_{thJC}	-	3.6	

SPECIFICATIONS ($T_J = 25\text{ °C}$, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Collector-Emitter Breakdown Voltage	BV_{CE}	$V_{GE} = 0\text{ V}, I_C = 250\text{ }\mu\text{A}$ $V_{GE} = 0\text{ V}, I_C = 1\text{ mA}$		600 600	- -	- -	V
Gate-Source Threshold Voltage (N)	$V_{GE(th)}$	$V_{CE} = V_{GE}, I_D = 250\text{ }\mu\text{A}$		4	5	6	V
Zero Gate Voltage Collector Current	I_{CES}	$V_{CE} = 600\text{ V}, V_{GE} = 0\text{ V}, T_J = 25\text{ °C}$		-	1	20	μA
		$V_{CE} = 600\text{ V}, V_{GE} = 0\text{ V}, T_J = 150\text{ °C}$		-	1000	-	μA
Gate-Emitter Leakage Current	I_{GES}	$V_{CE} = 0\text{ V}, V_{GS} = \pm 20\text{ V}$		-	-	100	nA
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$V_{GE} = 7\text{ V}$	$I_C = 20\text{ A}$	-	1.7	2.1	V
Forward Transconductance	g_{fs}	$V_{CE} = 20\text{ V}, I_C = 20\text{ A}$		-	15	-	S
Dynamic							
Input Capacitance	C_{ies}	$V_{GE} = 0\text{ V}, V_{CE} = 25\text{ V},$ $f = 500\text{ KHz}$		-	2800	-	pF
Output Capacitance	C_{oes}			-	33	-	
Reverse Transfer Capacitance	C_{res}			-	38	-	
Turn-on Energy	E_{on}	$V_{CE} = 400\text{ V}, V_{GE} = 0/15\text{ V},$ $I_C = 20\text{ A}, R_g = 10\text{ }\Omega$		-	0.45	-	nJ
Turn-off Energy	E_{off}			-	0.17	-	
Total Gate Charge	Q_g	$V_{GE} = 7\text{ V}$	$I_C = 20\text{ A}, V_{CE} = 400\text{ V}$	-	6.2	-	nC
Gate-Emitter Charge	Q_{ge}			-	17	-	
Gate to Collector Charge	Q_{gc}			-	16	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{CE} = 400\text{ V}, V_{GE} = 0/15\text{ V},$ $I_C = 20\text{ A}, R_g = 10\text{ }\Omega$		-	13	-	ns
Rise Time	t_r			-	32	-	
Turn-Off Delay Time	$t_{d(off)}$			-	112	-	
Fall Time	t_f			-	37	-	
Internal emitter inductance measured 5 mm	L_E			-	13	-	nH
Diode Characteristics							
Diode Forward Current	I_F	IGBT symbol showing the integral reverse junction diode		-	-	20	A
Pulsed Diode Forward Current	I_{FM}			-	-	60	
Diode Forward Voltage	V_F	$I_F = 20\text{ A}$		-	1.72	3.0	V
Reverse Recovery Time	t_{rr}	$T_J = 25\text{ °C}, I_F = 20\text{ A},$ $dI_F/dt = 200\text{ A}/\mu\text{s}, V_R = 400\text{ V}$		-	140	-	ns
Reverse Recovery Charge	Q_{rr}			-	0.26	-	μC
Reverse Recovery Current	I_{RRM}			-	10	-	A

SGH30N60RUFDTU alternative

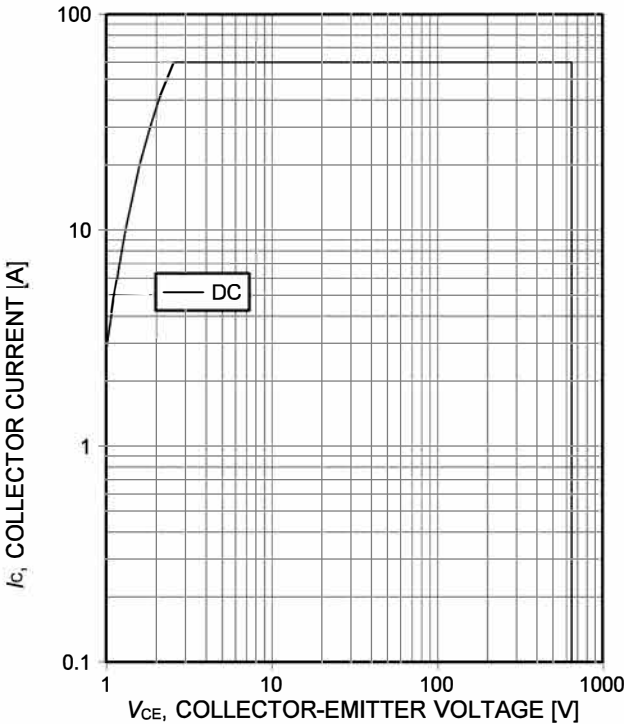


Figure 1. **Forward bias safe operating area**
 ($D=0, T_C=25^\circ\text{C}, T_{vj}\leq 175^\circ\text{C}; V_{GE}=15\text{V}$.
 Recommended use at $V_{GE}\geq 7.5\text{V}$)

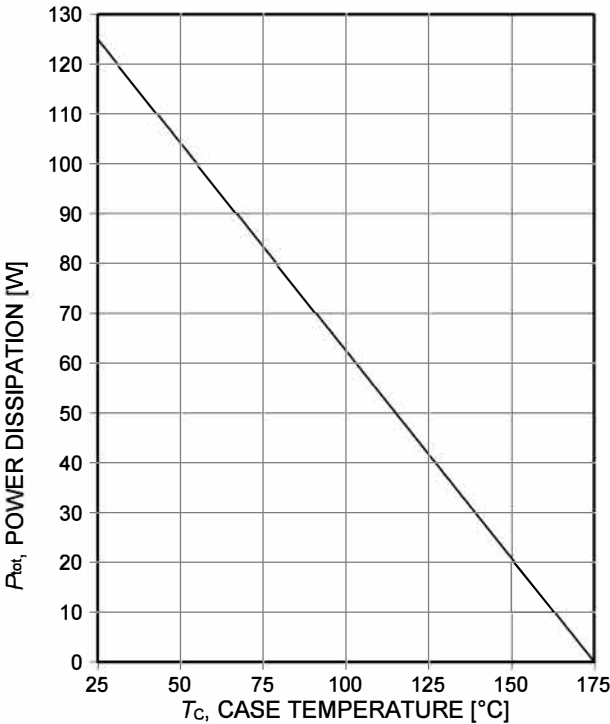


Figure 2. **Power dissipation as a function of case temperature**
 ($T_{vj}\leq 175^\circ\text{C}$)

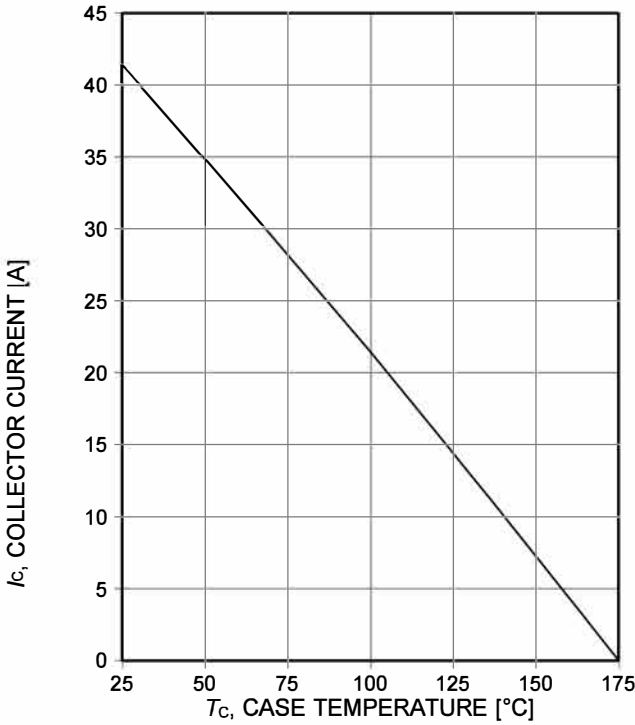


Figure 3. **Collector current as a function of case temperature**

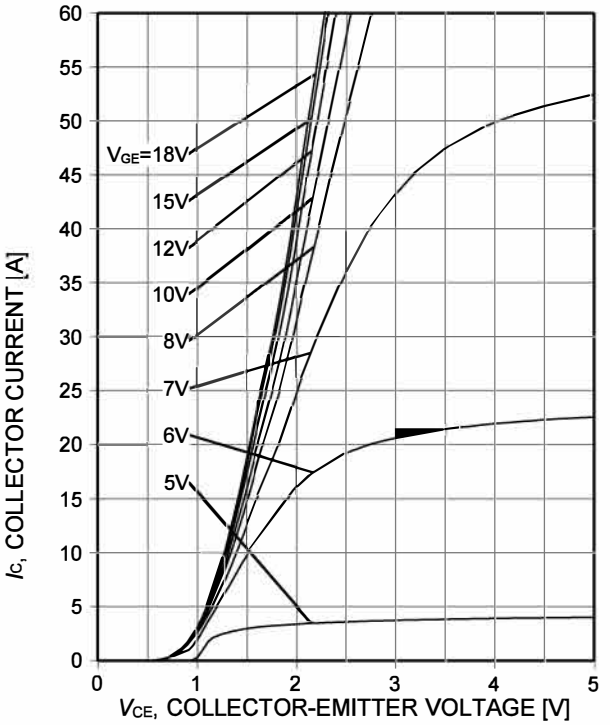


Figure 4. **Typical output characteristic**

SGH30N60RUFDTU alternative

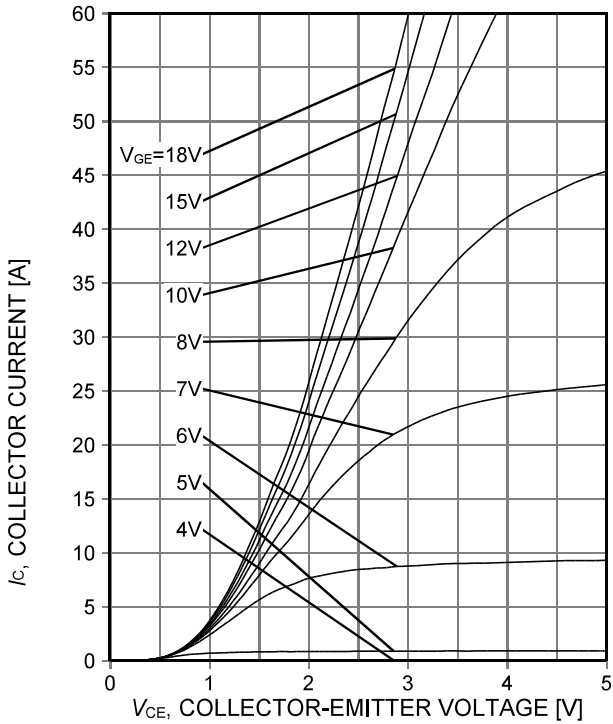


Figure 5. **Typical output characteristic**
($T_{vj}=150^{\circ}\text{C}$)

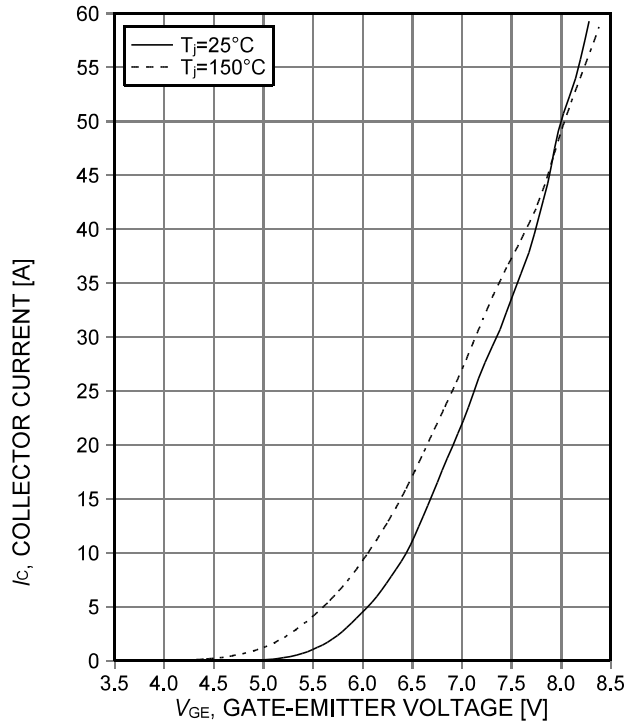


Figure 6. **Typical transfer characteristic**
($V_{CE}=20\text{V}$)

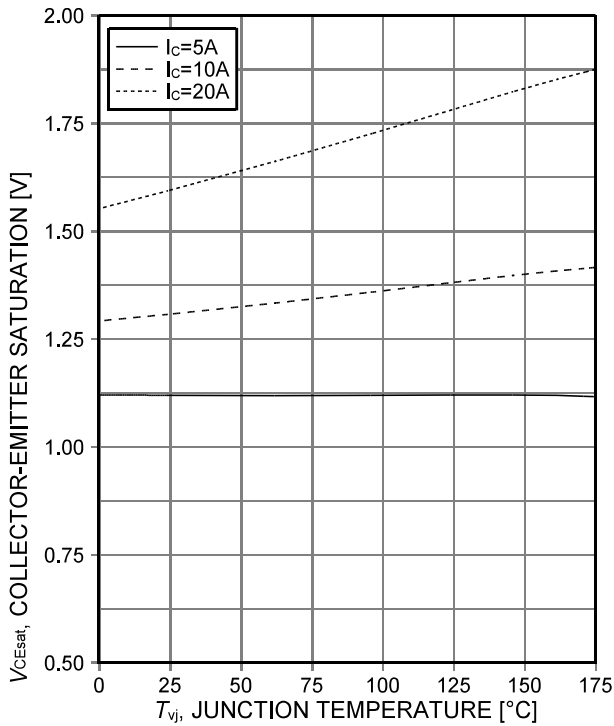


Figure 7. **Typical collector-emitter saturation voltage as a function of junction temperature**

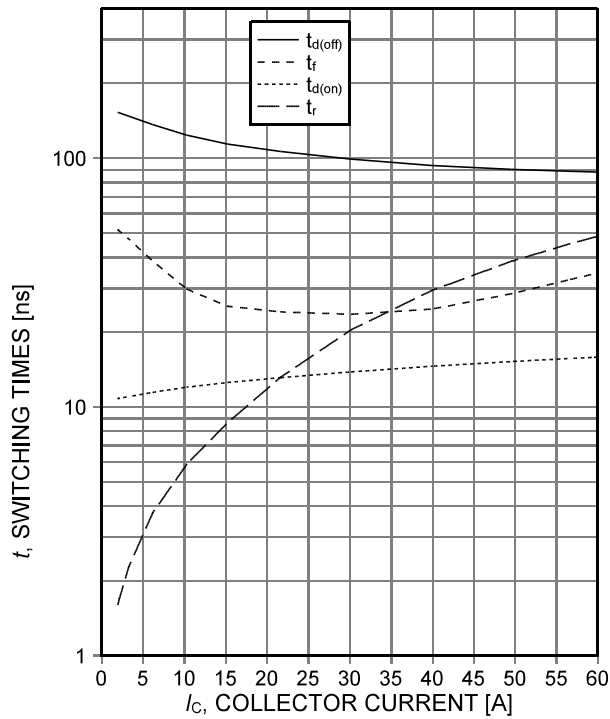


Figure 8. **Typical switching times as a function of collector current**

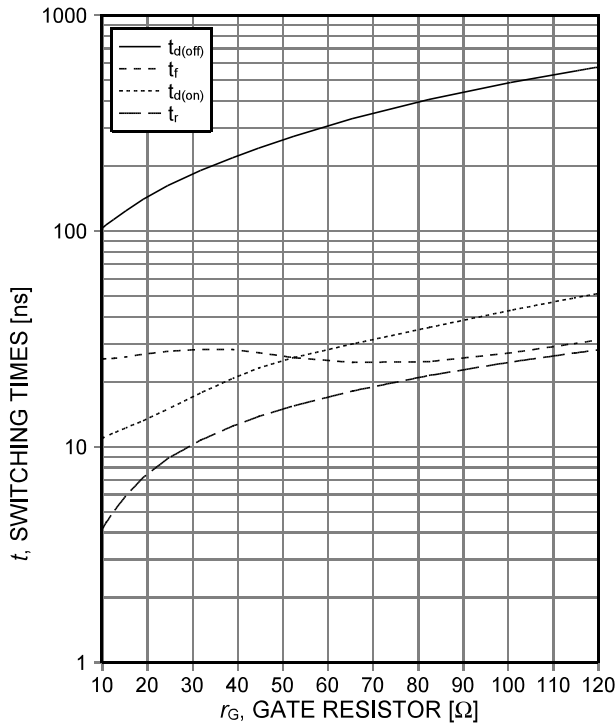


Figure 9. Typical switching times as a function of gate resistor

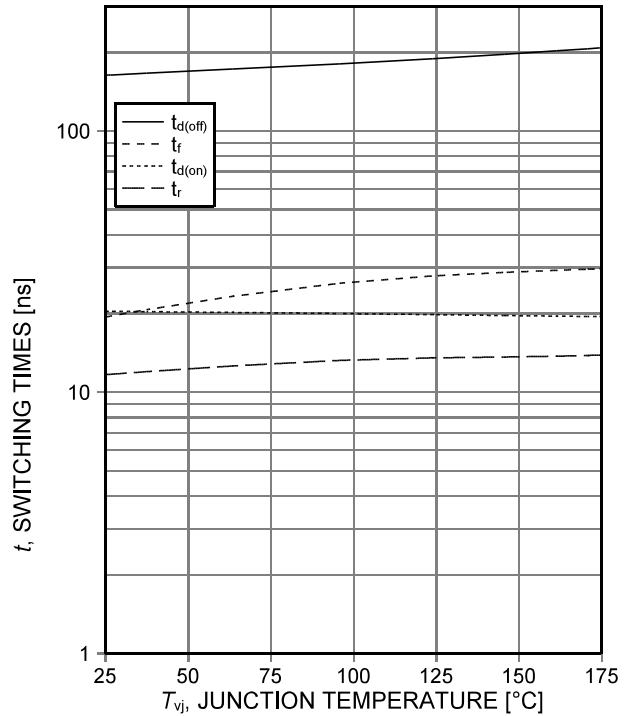


Figure 10. Typical switching times as a function of junction temperature

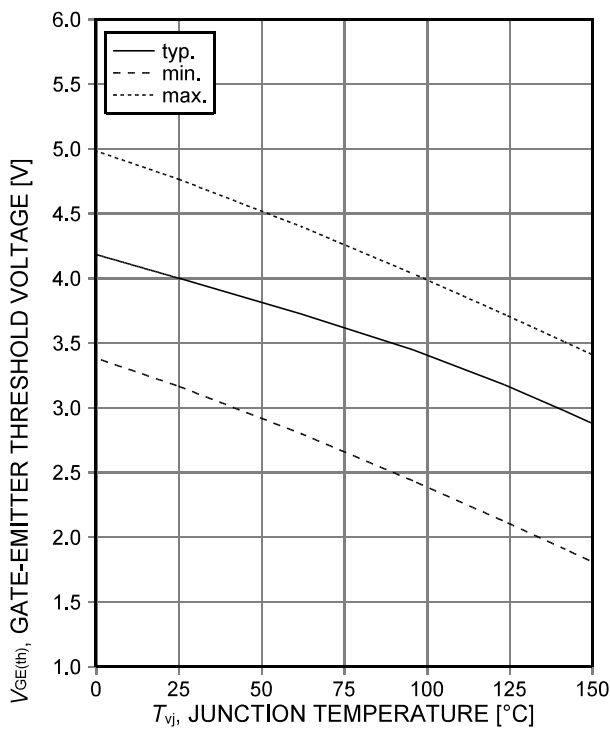


Figure 11. Gate-emitter threshold voltage as a function of junction temperature

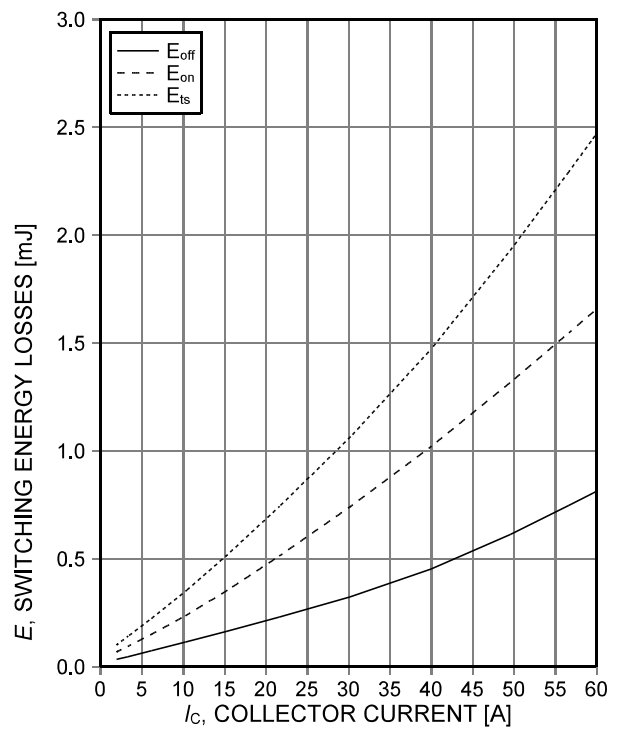


Figure 12. Typical switching energy losses as a function of collector current

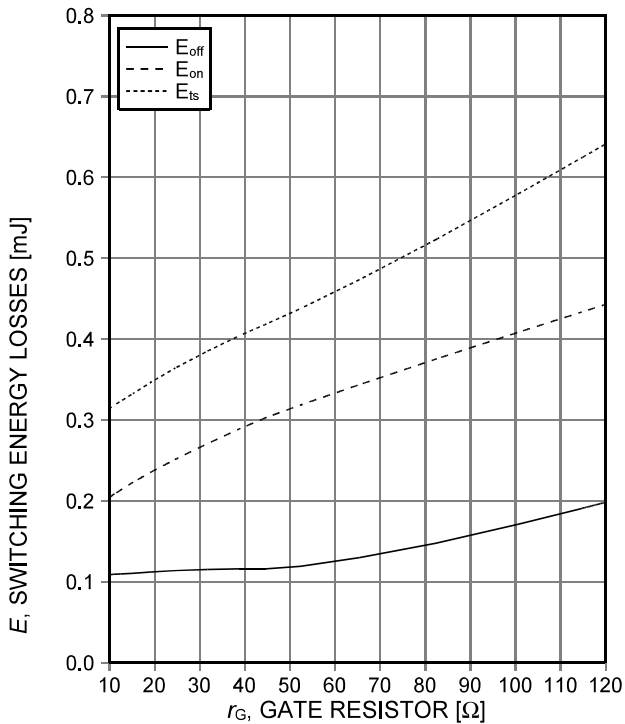


Figure 13. Typical switching energy losses as a function of gate resistor

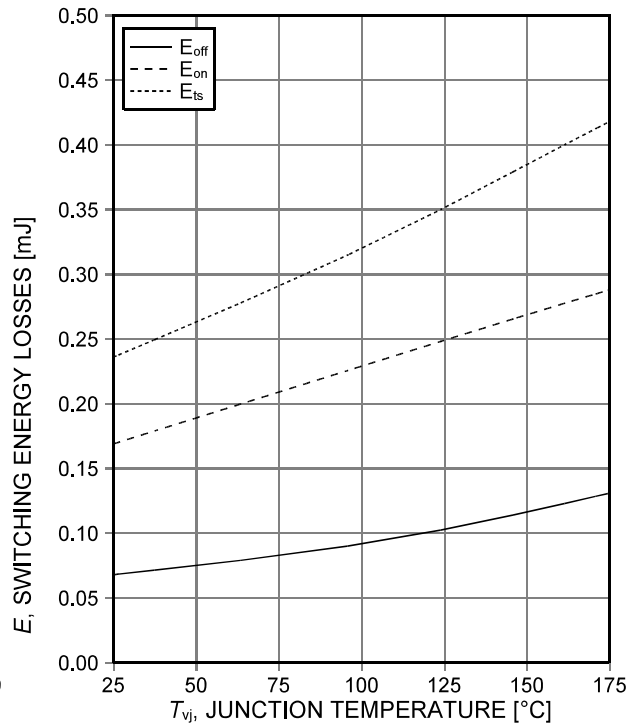


Figure 14. Typical switching energy losses as a function of junction temperature

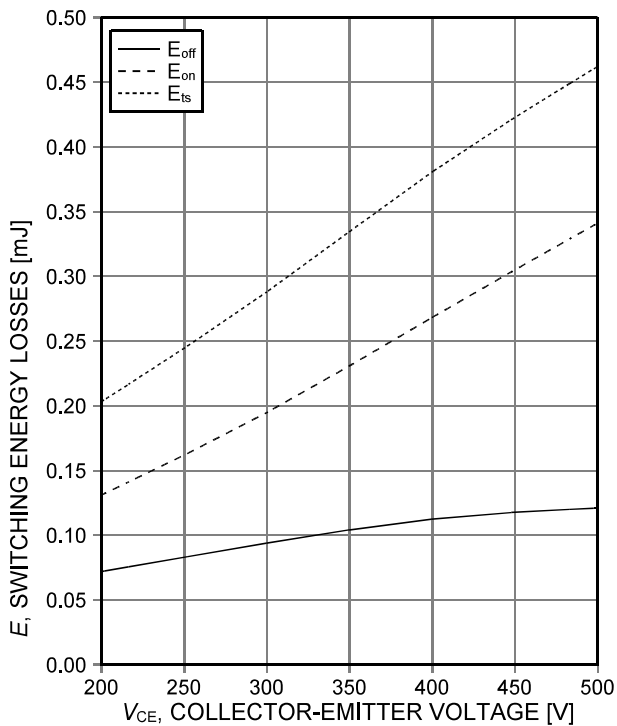


Figure 15. Typical switching energy losses as a function of collector emitter voltage

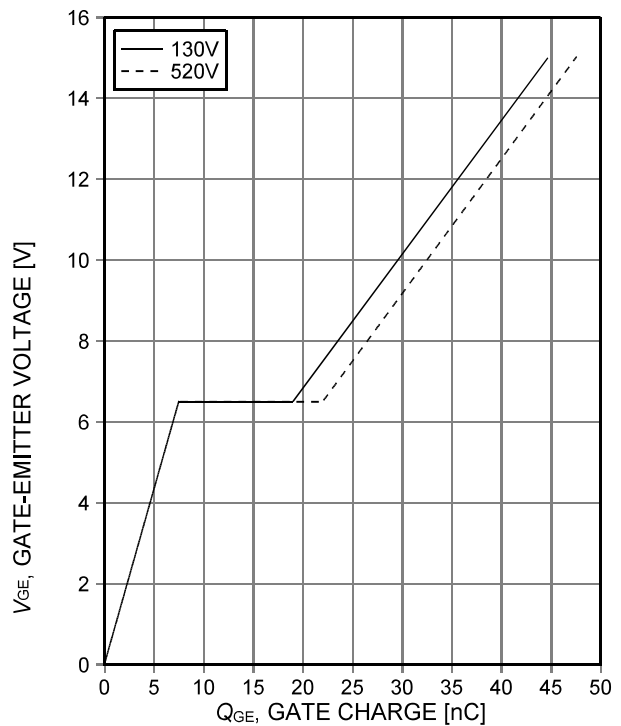


Figure 16. Typical gate charge

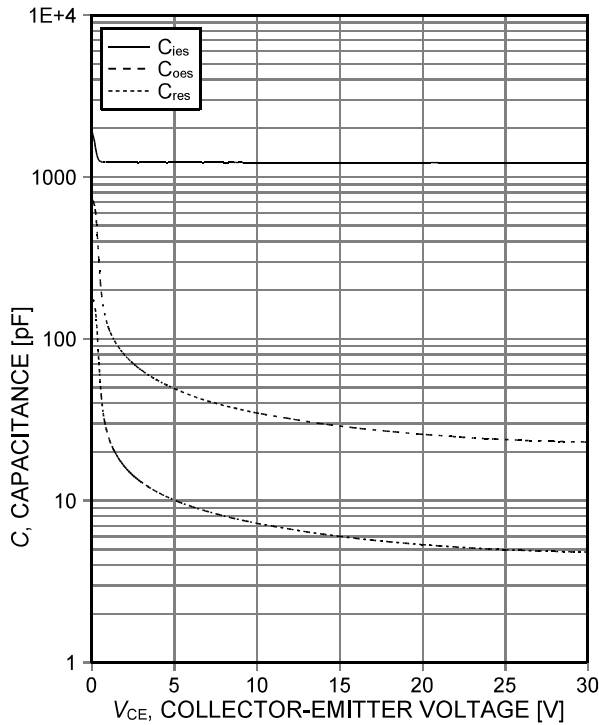


Figure 17. Typical capacitance as a function of collector-emitter voltage

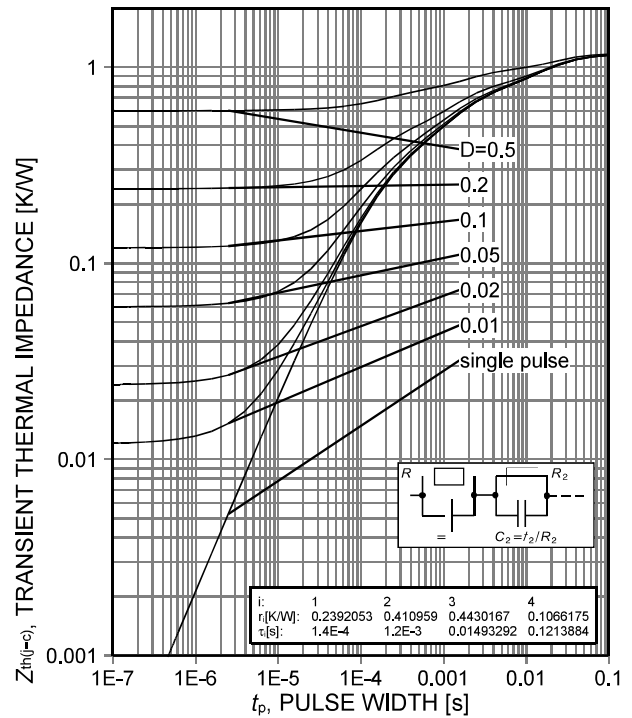


Figure 18. IGBT transient thermal impedance

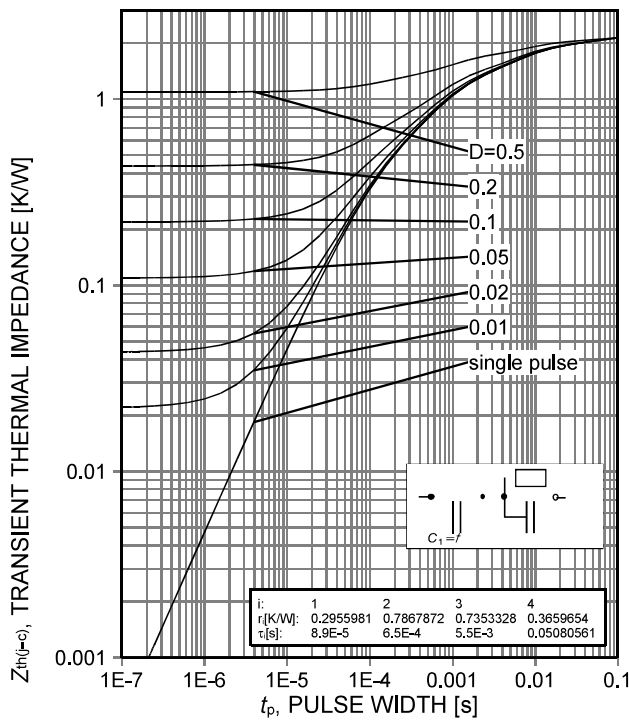


Figure 19. Diode transient thermal impedance as a function of pulse width

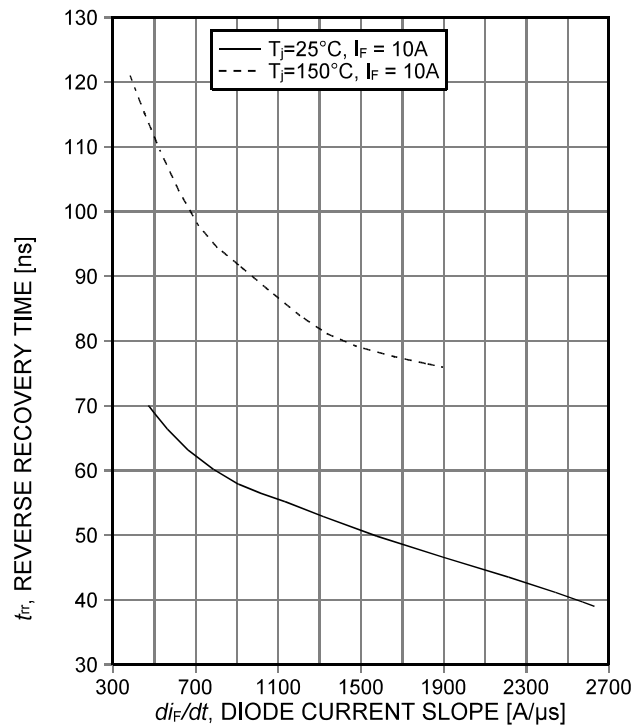


Figure 20. Typical reverse recovery time as a function of diode current slope

SGH30N60RUFDTU alternative

TO-3P

